

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT5007695

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHENMIN HU	05/18/2018
KHURRAM ZAFAR	05/18/2018
YE CHEN	05/18/2018
YUE MA	05/18/2018
RONG LV	05/18/2018
JUSTIN CHEN	05/18/2018
ABHISHEK VIKRAM	05/18/2018
YUAN XU	05/18/2018
PING ZHANG	05/18/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ANCHOR SEMICONDUCTOR INC.
<b>Street Address:</b>	3235 KIFER ROAD. SUITE 200
<b>City:</b>	SANTA CLARA
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<b>Postal Code:</b>	95051
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15944080
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)973-2595
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<b>Correspondent Name:</b>	VAN PELT, YI & JAMES LLP
<b>Address Line 1:</b>	10050 N. FOOTHILL BLVD., STE 200
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<b>ATTORNEY DOCKET NUMBER:</b>	ANCHP003
<b>NAME OF SUBMITTER:</b>	YEU-TING GEORGE CHENG

<b>SIGNATURE:</b>	/Yeu-Ting George Cheng/
<b>DATE SIGNED:</b>	06/14/2018
<b>Total Attachments: 2</b> source=ANCHP003 Executed Assignment#page1.tif source=ANCHP003 Executed Assignment#page2.tif	

## ASSIGNMENT OF PATENT APPLICATION

Whereas I/we the undersigned inventor(s) have invented certain new and useful improvements as set forth in the patent application entitled:

### PATTERN CENTRIC PROCESS CONTROL

for which I (we) have executed an application for a United States Letters Patent which was filed in the U.S. Patent and Trademark Office on April 03, 2018, and which bears the Application No. 15/944,080 (the "APPLICATION");

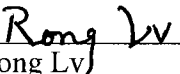

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we the undersigned inventor(s) hereby:

- 1) Sell, assign, and transfer to Anchor Semiconductor Inc., a California corporation having a place of business at 3235 Kifer Road, Suite 200, Santa Clara, CA, 95051, United States of America, (hereinafter referred to as "ASSIGNEE"), the entire worldwide right, title and interest in and to: (a) the APPLICATION; (b) any application to which the APPLICATION claims priority and any application at least in part based upon the APPLICATION; (c) all provisional, utility, divisional, continuation, continuation-in-part, substitute, renewal, reissue, and other applications related thereto which have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b), and (c) above; (e) any and all improvements and inventions disclosed in (a), (b), (c), and (d) above; (f) all rights of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of any provisional rights; and (g) all claims for past, present and future infringement of any patent in (d) above, including all rights to sue for and to receive and recover for the ASSIGNEE's own use all past, present, and future lost profits, royalties, and damages of whatever nature recoverable from an infringement of any patent in (d) above.
- 2) Authorize and request the issuance of any and all patent(s) resulting from said application or any division(s), continuation(s), continuation-in-part(s), substitutes(s), reissue(s), or other application(s) related thereof, which have been or may be filed in the United States or elsewhere in the world, to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said APPLICATION, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications. Such acts shall include (a) executing all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to the ASSIGNEE the rights, titles and interests herein conveyed; (b) communicating to the ASSIGNEE all known facts relating to any subject matter disclosed in the APPLICATION or any application or patent related to the APPLICATION; and (c) generally doing all lawful acts that the ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection and for vesting in the ASSIGNEE the rights, titles, and interests herein conveyed.

4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.

5) Warrant and represent that I/we have the rights, titles, and interests to convey as set forth herein, and have not entered, and will not enter into any assignment, grant, mortgage, license, contract, agreement, or understanding that conflicts with this assignment.

Signed on the date(s) indicated beside my (our) signature(s).

- 1) Signature:  Date: 18 May 2018  
Typed Name: Chenmin Hu
- 2) Signature:  Date: 18 May 2018  
Typed Name: Khurram Zafar
- 3) Signature:  Date: 18 May 2018  
Typed Name: Ye Chen
- 4) Signature:  Date: 18 May 2018  
Typed Name: Yue Ma
- 5) Signature:  Date: 18 May 2018  
Typed Name: Rong Lv
- 6) Signature:  Date: 18 May 2018  
Typed Name: Justin Chen
- 7) Signature:  Date: 18 May 2018  
Typed Name: Abhishek Vikram
- 8) Signature:  Date: 18 May 2018  
Typed Name: Yuan Xu
- 9) Signature:  Date: 18 May 2018  
Typed Name: Ping Zhang